



Further Electrical Characteristic

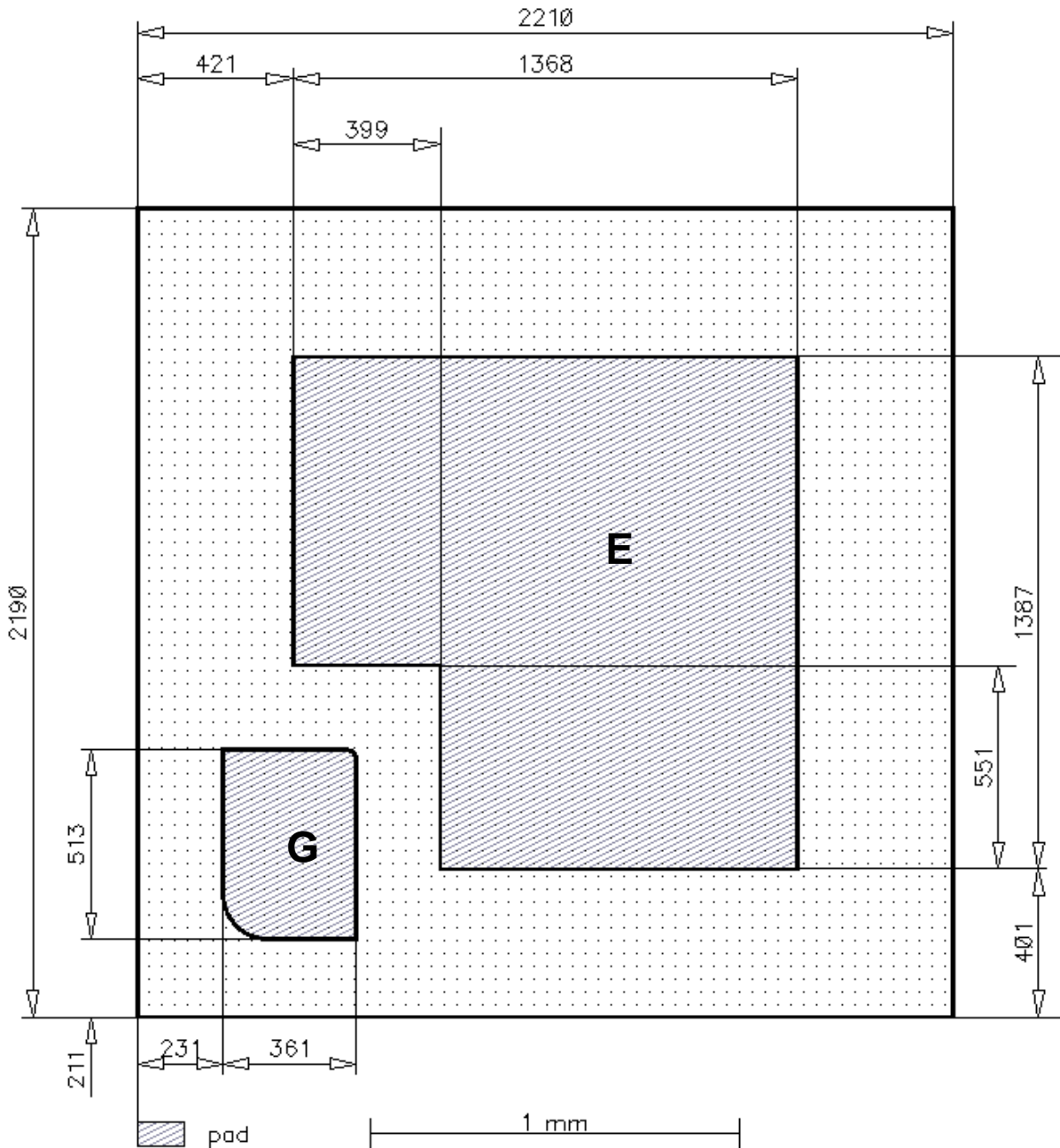
Switching characteristics and thermal properties are depending strongly on package design and mounting technology and can therefore not be specified for a bare die.

Further technical information about the performance of this chip in package PG-TO252-3 is given exemplarily at www.infineon.com/igbt. The chip qualification is independent of the qualification which is performed for the Discretets.

This chip data sheet refers to the device data sheet	IKD06N60R	Rev. 2.2
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Chip Drawing

Die-Size 2210 μm x 2190 μm



E = Emitter

G = Gate